19-2544; Rev 2; 2/07

MAXIM

LVECL/LVPECL 1:15 Differential Divide-by-1/Divide-by-2 Clock Driver

General Description

The MAX9322 low-skew 1:15 differential clock driver reproduces or divides one of two differential input clocks at 15 differential outputs. An input multiplexer selects from one of two input clocks with input switching frequency in excess of 1.0GHz. The 15 outputs are arranged in four banks with 2, 3, 4, and 6 outputs, respectively. Each output bank is individually programmable to provide a divide-by-1 or divide-by-2 frequency function.

The MAX9322 operates in LVPECL systems with a +2.375V to +3.8V supply or in LVECL systems with a -2.375V to -3.8V supply. A V_{BB} reference output provides compatibility with single-ended clock input signals and a master reset input provides a simultaneous reset on all outputs.

The MAX9322 is available in 52-pin TQFP and 68-pin QFN packages and is specified for operation over -40°C to +85°C. For 1:10 clock drivers, refer to the MAX9311/MAX9313 data sheet. For 1:5 clock drivers, refer to the MAX9316 data sheet.

Applications

Precision Clock Distribution

Low-Jitter Data Repeaters

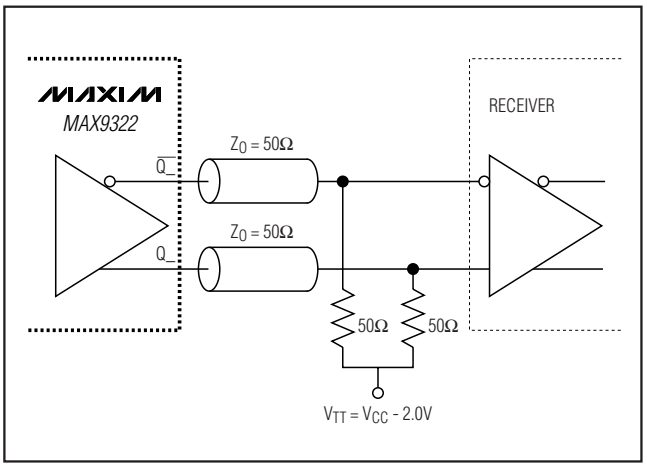
Central-Office Backplane Clock Distribution

DSLAM Backplane

Base Stations

ATE

Typical Operating Circuit



Features

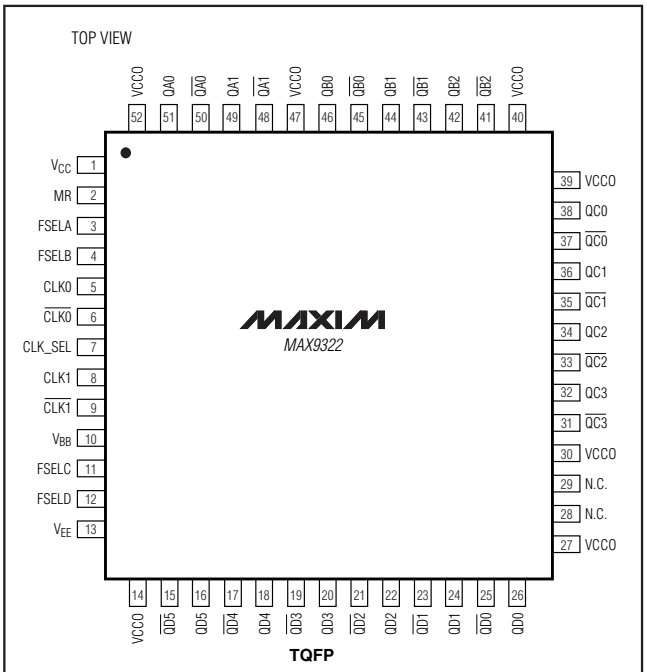
- **1.2ps (RMS) Maximum Random Jitter**
- **300mV Differential Output at 1.0GHz**
- **900ps Propagation Delay**
- **Selectable Divide-by-1 or Divide-by-2 Frequency Outputs**
- **Multiplexed 2:1 Input Function**
- **LVECL Operation from V_{EE} = -2.375V to -3.8V**
- **LVPECL Operation from V_{CC} = +2.375V to +3.8V**
- **ESD Protection: > 2kV Human Body Model**

Ordering Information

PART	TEMP RANGE	PIN-PACKAGE
MAX9322ECY	-40°C to +85°C	52 TQFP
MAX9322ETK*	-40°C to +85°C	68 QFN

**Future product—contact factory for availability.*

Pin Configurations



Pin Configurations continued at end of data sheet.

For pricing, delivery, and ordering information, please contact Maxim/Dallas Direct! at 1-888-629-4642, or visit Maxim's website at www.maxim-ic.com.

LVECL/LVPECL 1:15 Differential Divide-by-1/Divide-by-2 Clock Driver

ABSOLUTE MAXIMUM RATINGS

V_{CC} to V_{EE} 4.1V
Inputs and Outputs to V_{EE} .....-0.3V to (V_{CC} + 0.3V)
Differential Input Magnitude.....Lower of (V_{CC} - V_{EE}) and 3V
Continuous Output Current 50mA
Surge Output Current.....100mA
V_{BB} Sink/Source Current .....±0.65mA
Continuous Power Dissipation (T_A = +70°C)
Single-Layer PC Board
52-Pin TQFP (derate 15.4mW/°C above +70°C).....1230.8mW
68-Lead QFN (derate 27.8mW/°C above +70°C) ...2222.2mW
Multilayer PC Board
52-Pin TQFP (derate 19.1mW/°C above +70°C).....1529.6mW
68-Lead QFN (derate 38.5mW/°C above +70°C) ...3076.9mW
Junction-to-Ambient Thermal Resistance in Still Air
Single-Layer PC Board
52-Pin TQFP .....+65°C/W
68-Lead QFN .....+36°C/W
Multilayer PC Board
52-Pin TQFP .....+52.3°C/W
68-Lead QFN .....+26°C/W
Junction-to-Ambient Thermal Resistance with 500 LFPM Airflow
Single-Layer PC Board
52-Pin TQFP .....+50°C/W
68-Lead QFN .....+27°C/W
Multilayer PC Board
52-Pin TQFP .....+40°C/W
68-Lead QFN .....+20°C/W
Junction-to-Case Thermal Resistance
52-Pin TQFP .....+12.9°C/W
68-Lead QFN .....+2°C/W
Operating Temperature Range .....-40°C to +85°C
Junction Temperature .....+150°C
Storage Temperature Range .....-65°C to +150°C
ESD Protection
Human Body Model (Q_ _, $\overline{Q\_\ \_}$, CLK_SEL, FSEL_, $\overline{CLK\_}$, CLK_, MR, V_{BB}) .....±2kV
Soldering Temperature (10s).....+300°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

DC ELECTRICAL CHARACTERISTICS

((V_{CC} - V_{EE}) = 2.375V to 3.8V, outputs loaded with 50Ω ±1% to V_{CC} - 2V; CLK_SEL, FSEL_ = high or low; MR = low; $|V_{ID}|$ = 0.095V to the lower of (V_{CC} - V_{EE}) and 3V. Typical values are at (V_{CC} - V_{EE}) = 3.3V, V_{IHD} = V_{CC} - 1V, V_{ILD} = V_{CC} - 1.5V.) (Notes 1–4)

PARAMETER	SYMBOL	CONDITIONS	-40°C			+25°C			+85°C			UNITS
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	
SINGLE-ENDED INPUT (MR, FSEL_, CLK_SEL)												
Input High Voltage	V_{IH1}	Figure 1	V_{CC} - 1.155		V_{CC} - 0.88	V_{CC} - 1.155		V_{CC} - 0.88	V_{CC} - 1.155		V_{CC} - 0.88	V
Input Low Voltage	V_{IL1}	Figure 1	V_{CC} - 1.81		V_{CC} - 1.505	V_{CC} - 1.81		V_{CC} - 1.505	V_{CC} - 1.81		V_{CC} - 1.505	V
Input Current	I_{IN1}	MR, FSEL_, CLK_SEL = V_{IL} or V_{IH}	-15		+150	-15		+150	-15		+150	µA
DIFFERENTIAL INPUT (CLK_, $\overline{CLK\_}$)												
Single-Ended Input High Voltage	V_{IH2}	Figure 1	V_{CC} - 1.155		V_{CC} - 0.88	V_{CC} - 1.155		V_{CC} - 0.88	V_{CC} - 1.155		V_{CC} - 0.88	V
Single-Ended Input Low Voltage	V_{IL2}	Figure 1	V_{CC} - 1.81		V_{CC} - 1.505	V_{CC} - 1.81		V_{CC} - 1.505	V_{CC} - 1.81		V_{CC} - 1.505	V
High Voltage of Differential Input	V_{IHD}		V_{EE} + 1.2		V_{CC}	V_{EE} + 1.2		V_{CC}	V_{EE} + 1.2		V_{CC}	V
Low Voltage of Differential Input	V_{ILD}		V_{EE}		V_{CC} - 0.095	V_{EE}		V_{CC} - 0.095	V_{EE}		V_{CC} - 0.095	V

DC ELECTRICAL CHARACTERISTICS (continued)

((V_{CC} - V_{EE}) = 2.375V to 3.8V, outputs loaded with 50Ω ±1% to V_{CC} - 2V; CLK_SEL, FSEL_ = high or low; MR = low; $|V_{ID}|$ = 0.095V to the lower of (V_{CC} - V_{EE}) and 3V. Typical values are at (V_{CC} - V_{EE}) = 3.3V, V_{IHD} = V_{CC} - 1V, V_{ILD} = V_{CC} - 1.5V.) (Notes 1–4)

PARAMETER	SYMBOL	CONDITIONS	-40°C			+25°C			+85°C			UNITS
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	
Differential Input Voltage	V_{IHD} - V_{ILD}	For V_{CC} - V_{EE} < 3.0V	0.095		V_{CC} - V_{EE}	0.095		V_{CC} - V_{EE}	0.095		V_{CC} - V_{EE}	V
		For V_{CC} - V_{EE} ≥ 3.0V	0.095		3.0	0.095		3.0	0.095		3.0	
Input Current	I_{IN2}	CLK_, $\overline{CLK\_}$ = V_{IHD} or V_{ILD}	-150		+150	-150		+150	-150		+150	µA
OUTPUTS (Q_, $\overline{Q\_}$)												
Single-Ended Output High Voltage	V_{OH}	Figure 1	V_{CC} - 1.085		V_{CC} - 0.880	V_{CC} - 1.025		V_{CC} - 0.880	V_{CC} - 1.025		V_{CC} - 0.880	V
Single-Ended Output Low Voltage	V_{OL}	Figure 1	V_{CC} - 1.810		V_{CC} - 1.52	V_{CC} - 1.810		V_{CC} - 1.620	V_{CC} - 1.810		V_{CC} - 1.620	V
Differential Output Voltage	V_{OH} - V_{OL}	Figure 1	500			600			600			mV
REFERENCE												
Reference Voltage Output	V_{BB}	I_{BB} = ±0.5mA (Note 5)	V_{CC} - 1.41		V_{CC} - 1.25	V_{CC} - 1.41		V_{CC} - 1.25	V_{CC} - 1.41		V_{CC} - 1.25	V
SUPPLY												
Supply Current	I_{EE}	(Note 6)		50	85		66	115		80	130	mA

LVECL/LVPECL 1:15 Differential Divide-by-1/Divide-by-2 Clock Driver

AC ELECTRICAL CHARACTERISTICS

((VCC - VEE) = 2.375V to 3.8V; outputs loaded with 50Ω ±1% to VCC - 2V; input frequency ≤ 1000MHz; input transition time = 125ps (20% to 80%); CLK_SEL, FSEL_ = high or low, MR = low; VIHD = VEE + 1.2V to VCC; VILD = VEE to VCC - 0.4V; VIHD - VILD = 0.4V to 1V. Typical values are at (VCC - VEE) = 3.3V, VIHD = VCC - 1V, VILD = VCC - 1.5V.) (Note 7)

PARAMETER	SYMBOL	CONDITION	-40°C			+25°C			+85°C			UNITS
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	
Differential Input-to-Output Delay	t_{PLHD}, t_{PHLD}	Figure 2	700	900	1150	725	900	1180	750	950	1225	ps
Single-Ended CLK_/$\overline{CLK\_}$ to Output Delay	t_{PHLS}, t_{PLHS}	Figure 1	700	900	1170	700	900	1175	725	950	1250	ps
MR to Output Delay	t_{PD}	Figure 3	450		930	450		930	450		930	ps
Output-to-Output Skew	t_{SKOO}	(Note 8)			85			56			50	ps
Added Random Jitter	t_{RJ}	f_{IN} = 1.0GHz clock pattern (Note 9)			1.2			1.2			1.2	ps (RMS)
Added Deterministic Jitter	t_{DJ}	1Gbps 2^{23} - 1 PRBS pattern (Note 9)			61			61			61	ps_{P-P}
Switching Frequency	f_{MAX}	V_{OD} > 300mV	1.0			1.0			1.0			GHz
Differential Output Rise and Fall Time (20% to 80%)	t_R, t_F	Figure 2	200	260	400	200	260	400	200	240	400	ps

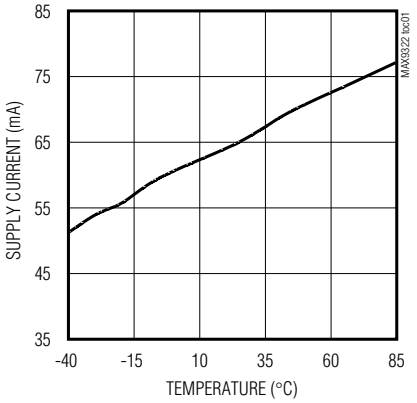
Note 1: Measurements are made with the device in thermal equilibrium.
Note 2: Current into a pin is defined as positive. Current out of a pin is defined as negative.
Note 3: Single-ended CLK_, $\overline{CLK\_}$ input operation is limited to VCC - VEE = 3.0V to 3.8V.
Note 4: DC parameters are production tested at TA = +25°C and guaranteed by design over the full operating temperature range.
Note 5: Use VBB as a reference for inputs of the same device only.
Note 6: All pins open except VCC and VEE.
Note 7: Guaranteed by design and characterization. Limits are set at ±6 sigma.
Note 8: Measured between outputs of the same parts at the signal crossing points under identical conditions for a same-edge transition.
Note 9: Device jitter added to a jitter-free input signal.

LVECL/LVPECL 1:15 Differential Divide-by-1/Divide-by-2 Clock Driver

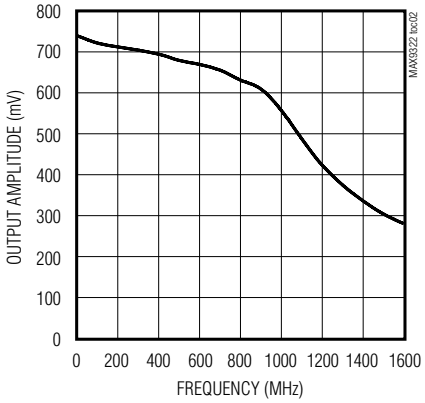
Typical Operating Characteristics

(V_{CC} - V_{EE} = 3.3V, V_{IHD} = V_{CC} - 1V, V_{ILD} = V_{CC} - 1.5V, V_{ID} = 500mV, CLK_SEL = 0, FSEL_ = 0, f_{IN} = 600MHz, T_A = +25°C, unless otherwise noted.)

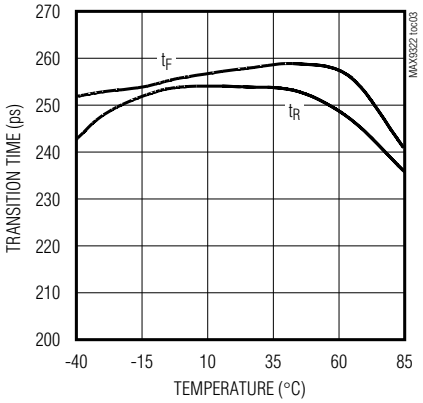
SUPPLY CURRENT, I_{EE} vs. TEMPERATURE



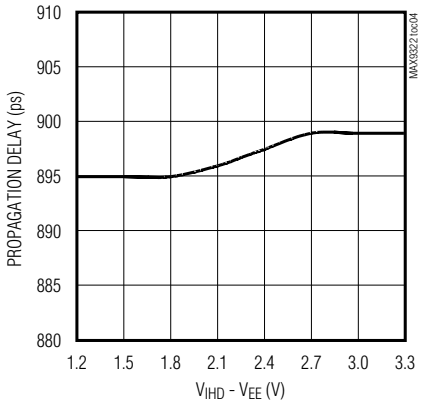
OUTPUT AMPLITUDE, V_{OH} - V_{OL} vs. FREQUENCY



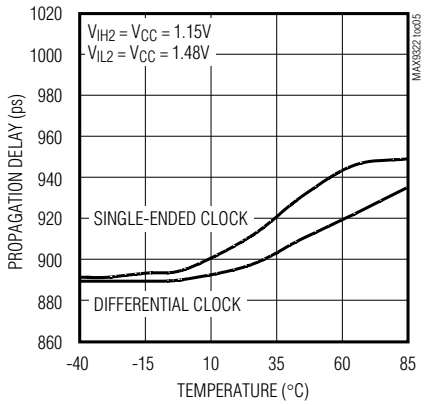
TRANSITION TIME vs. TEMPERATURE



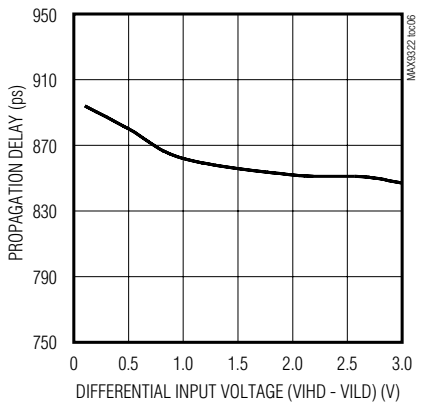
PROPAGATION DELAY vs. HIGH VOLTAGE OF DIFFERENTIAL INPUT, V_{IHD}



PROPAGATION DELAY vs. TEMPERATURE



PROPAGATION DELAY vs. DIFFERENTIAL INPUT VOLTAGE



LVECL/LVPECL 1:15 Differential Divide-by-1/Divide-by-2 Clock Driver

Pin Description

PIN		NAME	FUNCTION
TQFP	QFN		
1	2, 3	V_{CC}	Positive Power Supply. Powers input circuitry. Bypass each V_{CC} to V_{EE} with a 0.01µF and 0.1µF capacitor. Place the capacitors as close to the device as possible with the smaller value capacitor closest to the device.
2	4	MR	Single-Ended Master Reset. A high on MR sets all outputs to differential zero. A low on MR enables all outputs. MR is pulled to V_{EE} through a 75kΩ resistor.
3	5	FSELA	Single-Ended Frequency Select A. Selects the output frequency for bank A. Bank A consists of two differential outputs. A low on FSELA selects divide-by-1. A high on FSELA selects divide-by-2. FSELA is pulled to V_{EE} through a 75kΩ resistor.
4	6	FSELB	Single-Ended Frequency Select B. Selects the output frequency for bank B. Bank B consists of three differential outputs. A low on FSELB selects divide-by-1. A high on FSELB selects divide-by-2. FSELB is pulled to V_{EE} through a 75kΩ resistor.
5	7	CLK0	Noninverting Clock 0 Input. $\overline{CLK0}$ is pulled to V_{EE} through 75kΩ resistors.
6	8	$\overline{CLK0}$	Inverting Clock 0 Input. CLK0 is pulled to V_{CC} and to V_{EE} through a 75kΩ resistor.
7	9	CLK_SEL	Single-Ended Clock Selector Input. A low on CLK_SEL selects CLK0. A high on CLK_SEL selects CLK1. CLK_SEL is pulled to V_{EE} through a 75kΩ resistor.
8	10	CLK1	Noninverting Clock 1 Input. CLK1 is pulled to V_{EE} through a 75kΩ resistor.
9	11	$\overline{CLK1}$	Inverting Clock 1 Input. $\overline{CLK1}$ is pulled to V_{CC} and to V_{EE} through 75kΩ resistors.
10	12	V_{BB}	Reference Voltage Output. Connect V_{BB} to CLK_ or $\overline{CLK\_}$ to provide a reference for single-ended operation. When used, bypass with a 0.01µF ceramic capacitor to V_{CC}; otherwise leave open.
11	13	FSELC	Single-Ended Frequency Select C. Selects the output frequency for bank C. Bank C consists of four differential outputs. A low on FSELC selects divide-by-1. A high on FSELC selects divide-by-2. FSELC is pulled to V_{EE} through a 75kΩ resistor.
12	14	FSELD	Single-Ended Frequency Select D. Selects the output frequency for bank D. Bank D consists of six differential outputs. A low on FSELD selects divide-by-1. A high on FSELD selects divide-by-2. FSELD is pulled to V_{EE} through a 75kΩ resistor.
13	15, 16	V_{EE}	Negative Power-Supply Input
14, 27, 30, 39, 40, 47, 52	19, 20, 33, 36, 37, 40, 49, 50, 53, 54, 61, 66, 67	V_{CCO}	Output Driver Positive Power Supply. Powers device output drivers. Bypass each V_{CCO} to V_{EE} with a 0.01µF and 0.1µF capacitor. Place the capacitors as close to the device as possible with the smaller value capacitor closest to the device.
15	21	$\overline{QD5}$	Inverting QD5 Output. Typically terminate with 50Ω resistor to V_{CC} - 2V.
16	22	QD5	Noninverting QD5 Output. Typically terminate with 50Ω resistor to V_{CC} - 2V.
17	23	$\overline{QD4}$	Inverting QD4 Output. Typically terminate with 50Ω resistor to V_{CC} - 2V.
18	24	QD4	Noninverting QD4 Output. Typically terminate with 50Ω resistor to V_{CC} - 2V.

Pin Description (continued)

PIN		NAME	FUNCTION
TQFP	QFN		
19	25	$\overline{QD3}$	Inverting QD3 Output. Typically terminate with 50Ω resistor to V_{CC} - 2V.
20	26	QD3	Noninverting QD3 Output. Typically terminate with 50Ω resistor to V_{CC} - 2V.
21	27	$\overline{QD2}$	Inverting QD2 Output. Typically terminate with 50Ω resistor to V_{CC} - 2V.
22	28	QD2	Noninverting QD2 Output. Typically terminate with 50Ω resistor to V_{CC} - 2V.
23	29	$\overline{QD1}$	Inverting QD1 Output. Typically terminate with 50Ω resistor to V_{CC} - 2V.
24	30	QD1	Noninverting QD1 Output. Typically terminate with 50Ω resistor to V_{CC} - 2V.
25	31	$\overline{QD0}$	Inverting QD0 Output. Typically terminate with 50Ω resistor to V_{CC} - 2V.
26	32	QD0	Noninverting QD0 Output. Typically terminate with 50Ω resistor to V_{CC} - 2V.
28, 29	1, 17, 18, 34, 35, 38, 39, 51, 52, 68	N.C.	No Connection. Not internally connected.
31	41	$\overline{QC3}$	Inverting QC3 Output. Typically terminate with 50Ω resistor to V_{CC} - 2V.
32	42	QC3	Noninverting QC3 Output. Typically terminate with 50Ω resistor to V_{CC} - 2V.
33	43	$\overline{QC2}$	Inverting QC2 Output. Typically terminate with 50Ω resistor to V_{CC} - 2V.
34	44	QC2	Noninverting QC2 Output. Typically terminate with 50Ω resistor to V_{CC} - 2V.
35	45	$\overline{QC1}$	Inverting QC1 Output. Typically terminate with 50Ω resistor to V_{CC} - 2V.
36	46	QC1	Noninverting QC1 Output. Typically terminate with 50Ω resistor to V_{CC} - 2V.
37	47	$\overline{QC0}$	Inverting QC0 Output. Typically terminate with 50Ω resistor to V_{CC} - 2V.
38	48	QC0	Noninverting QC0 Output. Typically terminate with 50Ω resistor to V_{CC} - 2V.
41	55	$\overline{QB2}$	Inverting QB2 Output. Typically terminate with 50Ω resistor to V_{CC} - 2V.
42	56	QB2	Noninverting QB2 Output. Typically terminate with 50Ω resistor to V_{CC} - 2V.
43	57	$\overline{QB1}$	Inverting QB1 Output. Typically terminate with 50Ω resistor to V_{CC} - 2V.
44	58	QB1	Noninverting QB1 Output. Typically terminate with 50Ω resistor to V_{CC} - 2V.
45	59	$\overline{QB0}$	Inverting QB0 Output. Typically terminate with 50Ω resistor to V_{CC} - 2V.
46	60	QB0	Noninverting QB0 Output. Typically terminate with 50Ω resistor to V_{CC} - 2V.
48	62	$\overline{QA1}$	Inverting QA1 Output. Typically terminate with 50Ω resistor to V_{CC} - 2V.
49	63	QA1	Noninverting QA1 Output. Typically terminate with 50Ω resistor to V_{CC} - 2V.
50	64	$\overline{QA0}$	Inverting QA0 Output. Typically terminate with 50Ω resistor to V_{CC} - 2V.
51	65	QA0	Noninverting QA0 Output. Typically terminate with 50Ω resistor to V_{CC} - 2V.
—	EP	V_{EE}	The exposed pad of the QFN package is internally connected to V_{EE}. Refer to Application Note HFAN-08.1.

LVECL/LVPECL 1:15 Differential Divide-by-1/Divide-by-2 Clock Driver

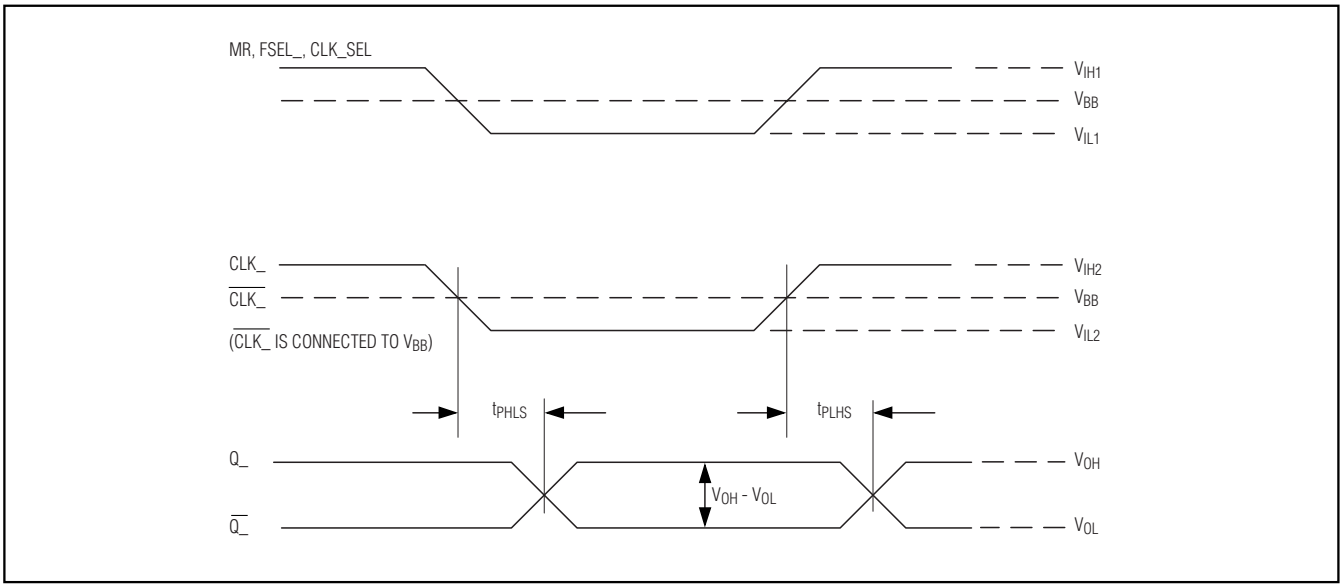


Figure 1. Timing Diagram for Single-Ended Inputs

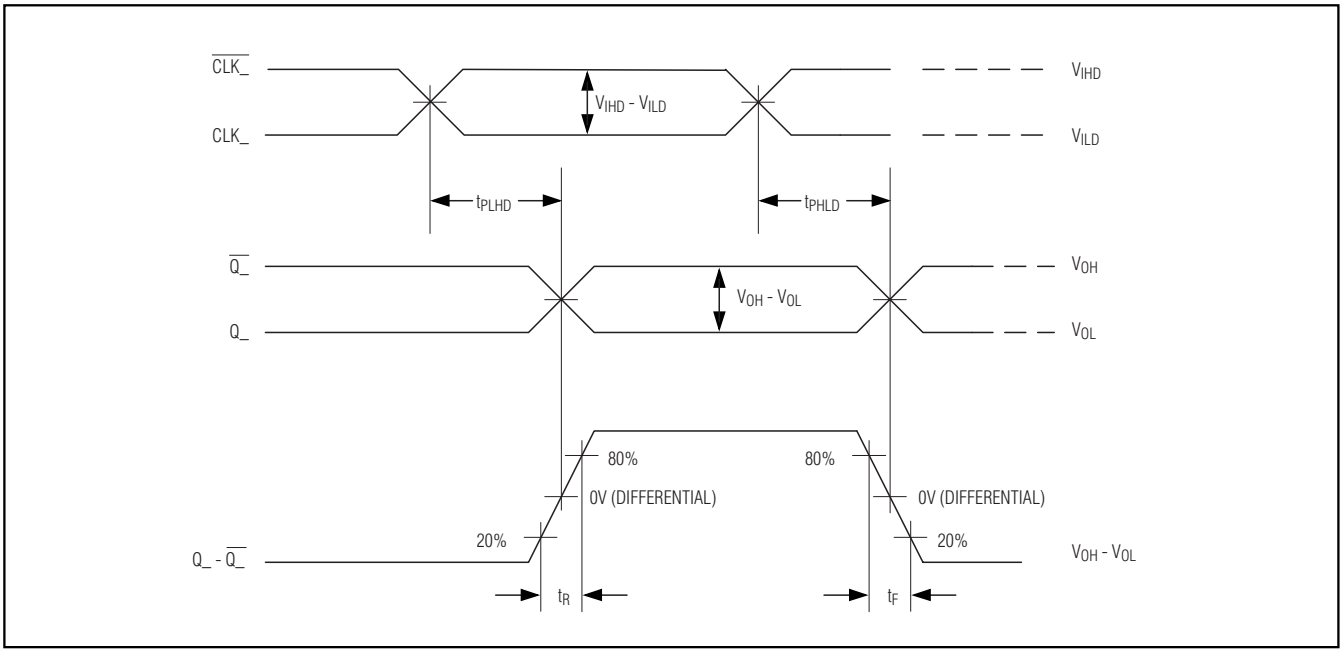


Figure 2. Timing Diagram for Differential Inputs

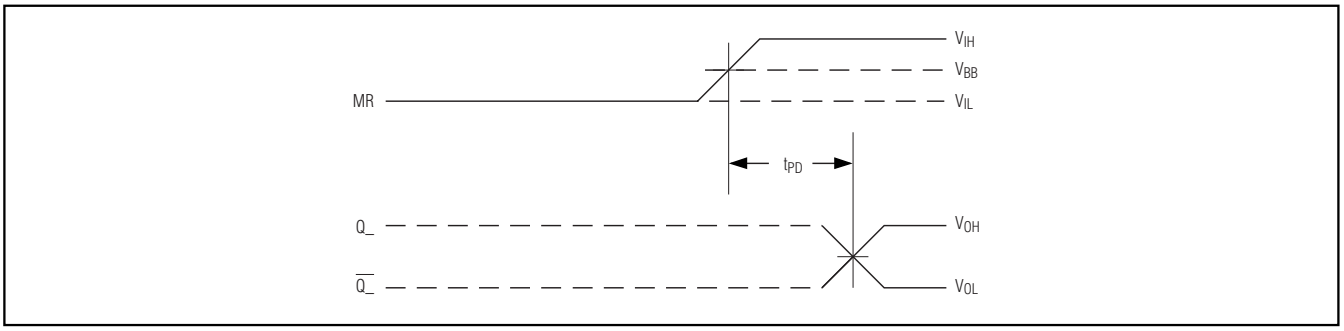


Figure 3. Timing Diagram for MR

Detailed Description

The MAX9322 low-skew 1:15 differential clock driver reproduces or divides one of two differential input clocks at 15 differential outputs. An input multiplexer selects from one of two input clocks with input frequency operation in excess of 1.0GHz. The 15 outputs are arranged into four banks with 2, 3, 4, and 6 outputs, respectively. Each output bank is individually programmable to provide a divide-by-1 or divide-by-2 frequency function.

LVECL/LVPECL Operation

Output levels are referenced to V_{CC} and are LVPECL or LVECL, depending on the level of the V_{CC} supply. With V_{CC} connected to a positive supply and V_{EE} connected to ground, the outputs are LVPECL. The outputs are LVECL when V_{CC} is connected to ground and V_{EE} is connected to a negative supply. When interfacing to differential LVPECL signals, the V_{CC} range is 2.375V to 3.8V (V_{EE} = 0), allowing high-performance clock distribution in systems with nominal 2.5V and 3.3V supplies. When interfacing to differential LVECL, the V_{EE} range is -2.375V to -3.8V (V_{CC} = 0).

Control Inputs (FSEL_, CLK_SEL, MR)

The MAX9322 provides four output banks: A, B, C, and D. Bank A consists of two differential output pairs. Bank B consists of three differential output pairs. Bank C consists of four differential output pairs. Bank D consists of six differential output pairs. FSEL_ selects the output clock frequency for a bank. A low on FSEL_ selects divide-by-1 frequency operation while a high on FSEL_ selects divide-by-2 operation. CLK_SEL selects CLK0 or CLK1 as the input signal. A low on CLK_SEL selects CLK0 while a high selects CLK1.

Master reset (MR) enables all outputs. CLK_SEL and FSEL_ are asynchronous. Changes to the control inputs (CLK_SEL, FSEL_) or on power-up cause indeterminate output states requiring a MR assertion to resynchronize any divide-by-2 outputs (Figure 4). A low on MR activates all outputs for normal operation. A high on MR resets all outputs to differential low condition. See Table 1.

Input Termination Resistors

Differential inputs CLK_ and $\overline{CLK\_}$ are biased to guarantee a known state (differential low) if the inputs are left open. CLK_ is internally pulled to V_{EE} through a 75kΩ resistor. $\overline{CLK\_}$ is internally pulled to V_{CC} and to V_{EE} through 75kΩ resistors.

Single-ended inputs FSEL_, MR, and CLK_SEL are internally pulled to V_{EE} through a 75kΩ resistor.

Differential Clock Input

The MAX9322 accepts two differential or single-ended clock inputs, CLK0/$\overline{CLK0}$ and CLK1/$\overline{CLK1}$. CLK_SEL selects between CLK0/$\overline{CLK0}$ and CLK1/$\overline{CLK1}$. A low on CLK_SEL selects CLK0/$\overline{CLK0}$. A high on CLK_SEL selects CLK1/$\overline{CLK1}$. See Table 1.

Differential CLK_ inputs must be at least V_{BB} ±95mV to switch the outputs to the V_{OH} and V_{OL} levels specified in the *DC Electrical Characteristics* table. The maximum magnitude of the differential signal applied to the differential clock input is the lower of (V_{CC} - V_{EE}) and 3.0V. This limit also applies to the difference between any reference voltage input and a single-ended input. Specifications for the high and low voltages of a differential input (V_{IHD} and V_{ILD}) and the differential input voltage (V_{IHD} - V_{ILD}) apply simultaneously.

Table 1. Function Table

PIN	FUNCTION	
	LOW OR OPEN	HIGH
FSEL_	Divide-by-1	Divide-by-2
CLK_SEL	CLK0	CLK1
MR*	Active	Reset

**A master reset is required following power-up or changes to input functions to prevent indeterminant output states.*

LVECL/LVPECL 1:15 Differential Divide-by-1/Divide-by-2 Clock Driver

Single-Ended Inputs and V_{BB}

The differential clock input can be configured to accept a single-ended input when operating at V_{CC} - V_{EE} = 3.0V to 3.8V. Connect V_{BB} to the inverting or noninverting input of the differential input as a reference for single-ended operation. The differential CLK_ input is converted to a noninverting, single-ended input by connecting V_{BB} to $\overline{CLK\_}$ and connecting the single-ended input signal to CLK. Similarly, an inverting configuration is obtained by connecting V_{BB} to CLK_ and connecting the single-ended input to $\overline{CLK\_}$.

The single-ended inputs FSEL_, CLK_SEL, and MR are internally referenced to V_{BB}. All single-ended inputs (FSEL_, CLK_SEL, MR, and any CLK_ in single-ended mode) can be driven to V_{CC} and V_{EE} or with a single-ended LVPECL/LVECL signal. The single-ended input must be at least V_{BB} ±95mV to switch the outputs to the V_{OH} and V_{OL} levels specified in the *DC Electrical Characteristics* table. When using the V_{BB} reference output, bypass V_{BB} with a 0.01µF ceramic capacitor to V_{CC}. Leave V_{BB} open when not used. The V_{BB} reference can source or sink 0.5mA. Use V_{BB} as a reference for the same device only.

Applications Information

Supply Bypassing

Bypass each V_{CC} and V_{CCO} to V_{EE} with high-frequency surface-mount ceramic 0.01µF and 0.1µF capacitors in parallel as close to the device as possible, with the 0.01µF capacitor closest to the device. Use multiple parallel vias to minimize parasitic inductance. When using the V_{BB} reference output, bypass V_{BB} to V_{CC} with a 0.01µF ceramic capacitor.

Controlled-Impedance Traces

Input and output trace characteristics affect the performance of the MAX9322. Connect input and output signals with 50Ω characteristic impedance traces. Minimize the number of vias to prevent impedance discontinuities. Reduce reflections by maintaining the 50Ω characteristic impedance through cables and connectors. Reduce skew within a differential pair by matching the electrical length of the traces.

Output Termination

Terminate outputs with 50Ω to V_{CC} - 2V or use an equivalent Thevenin termination. When a single-ended signal is taken from a differential output, terminate both outputs. For example, if QA0 is used as a single-ended output, terminate both QA0 and $\overline{QA0}$.

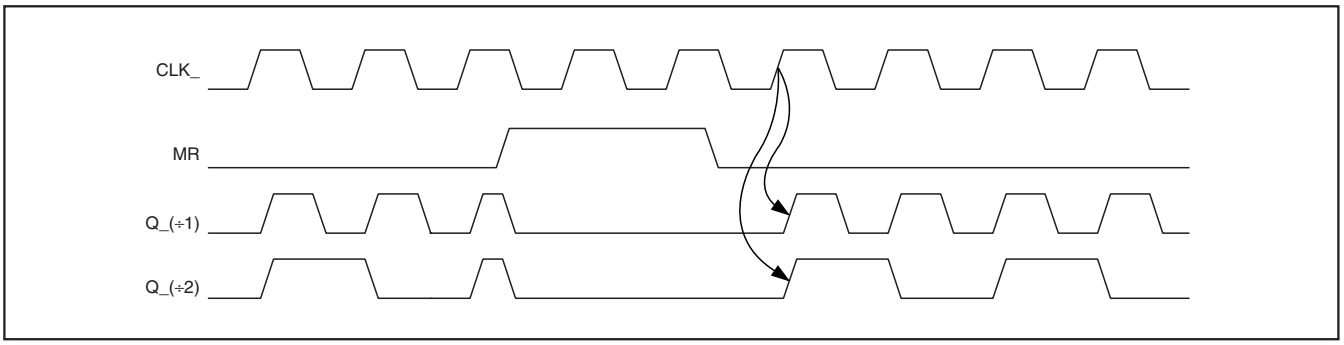
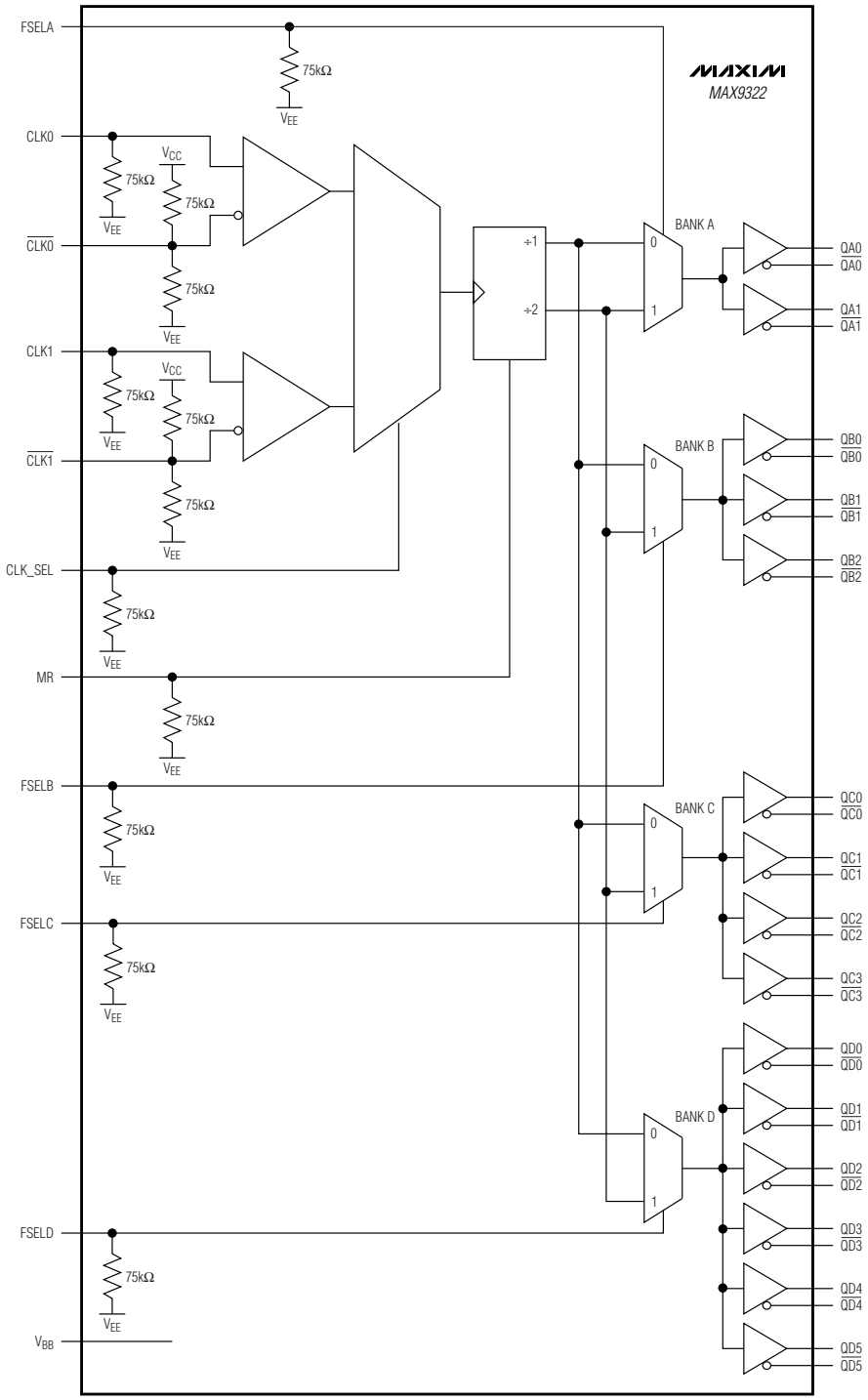


Figure 4. Timing Diagram for MR Resynchronization

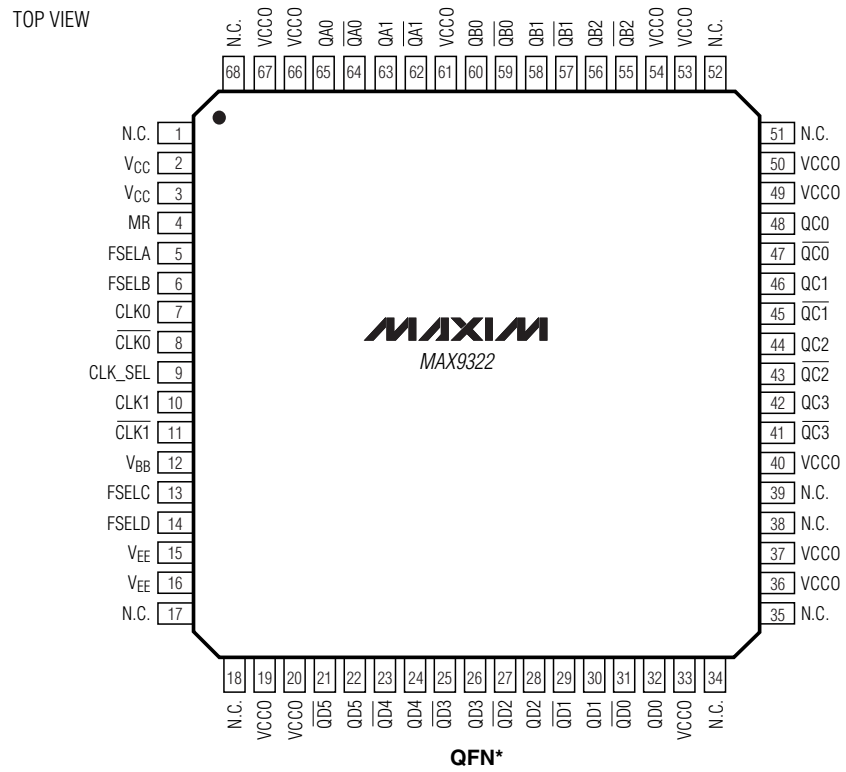
LVECL/LVPECL 1:15 Differential Divide-by-1/Divide-by-2 Clock Driver

Functional Diagram



LVECL/LVPECL 1:15 Differential Divide-by-1/Divide-by-2 Clock Driver

Pin Configurations (continued)



QFN*

THE EXPOSED PAD OF THE QFN PACKAGE MUST BE SOLDERED TO V_{EE} FOR PROPER THERMAL AND ELECTRICAL OPERATION OF THE MAX9322.

Chip Information

TRANSISTOR COUNT: 2063

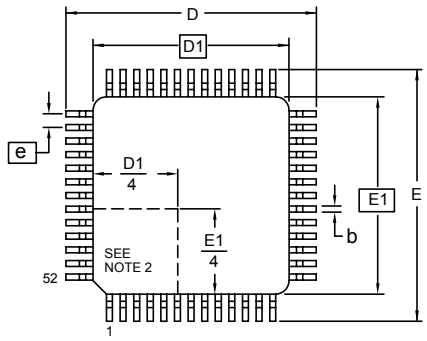
PROCESS: Bipolar

LVECL/LVPECL 1:15 Differential Divide-by-1/Divide-by-2 Clock Driver

Package Information

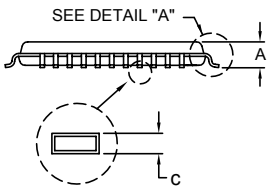
(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to **www.maxim-ic.com/packages**.)

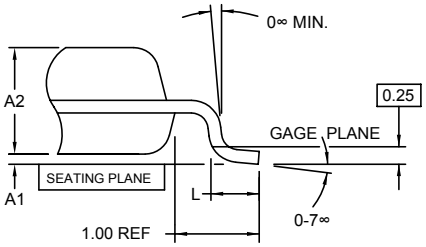
52L TQFP.EPS



TOP VIEW

DIM	MIN	NOM	MAX
A	-	-	1.20
A1	0.05	0.10	0.15
A2	0.95	1.00	1.05
b	0.22	0.32	0.38
c	0.09	-	0.20
D	11.80	12.00	12.20
D1	10.00 BSC		
E	11.80	12.00	12.20
E1	10.00 BSC		
e	0.65 BSC		
L	0.45	0.60	0.75





DETAIL A

NOTES:
1. DIMENSIONS D1 AND E1 INCLUDE MOLD MISMATCH, BUT DO NOT INCLUDE MOLD PROTRUSION; ALLOWABLE PROTRUSION IS 0.254 MM ON D1 AND E1.
2. DETAILS OF PIN 1 IDENTIFIER ARE OPTIONAL BUT MUST BE LOCATED WITHIN THE ZONE INDICATED.
3. ALLOWABLE DAMBAR PROTRUSION IS 0.08 MM TOTAL IN EXCESS OF THE B DIMENSION AT MAXIMUM MATERIAL CONDITION. PROTRUSION NOT TO BE LOCATED ON LOWER RADIUS OR FOOT OF LEAD.
4. DIMENSIONS ARE IN MILLIMETERS.
5. MEETS JEDEC MS-206.

DALLAS SEMICONDUCTOR MAXIM

PROPRIETARY INFORMATION

TITLE: PACKAGE OUTLINE 52L TQFP, 10x10x1.0 MM

APPROVAL	DOCUMENT CONTROL NO.	REV.	
	21-0146	A	1/1

Revision History

Pages changed at Rev 2: 1, 5, 13

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